IGBT - Field Stop 600 V, 80 A

FGH80N60FD

Description

Using Novel Field Stop IGBT Technology, ON Semiconductor's field stop IGBTs offer the optimum performance for induction heating, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.8 V @ I_C = 40 A
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

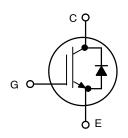
Applications

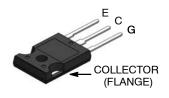
• Induction Heating, PFC, Telecom, ESS



ON Semiconductor®

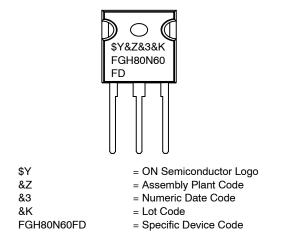
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TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Description	Symbol	Ratings	Unit	
Collector to Emitter Voltage	V _{CES}	600	V	
Gate to Emitter Voltage	V _{GES}	±20	V	
Collector Current	Tc = 25°C	Ι _C	80	А
	Tc = 100°C		40	Α
Pulsed Collector Current	Tc = 25°C	I _{CM} (Note 1)	160	Α
Maximum Power Dissipation	Tc = 25°C	PD	290	W
	Tc = 100°C		116	W
Operating Junction Temperature	TJ	-55 to +150	°C	
Storage Temperature Range	T _{stg}	-55 to +150	°C	
Maximum Lead Temperature for Soldering, 1/8" from C	TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Max.	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.43	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$ (Diode)	1.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FGH80N60FDTU	FGH80N60FD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•				
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I _C = 250 μ A	600	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	V_{GE} = 0 V, I _C = 250 μ A	-	0.6	_	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs						-
G-E Threshold Voltage	V _{GE(th)}	I_C = 250 μ A, V_{CE} = V_{GE}	4.5	5.5	7.0	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	1.8	2.4	V
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 125°C	-	2.05	-	V
DYNAMIC CHARACTERISTICS	•	•			•	
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	2110	-	pF
Output Capacitance	C _{oes}	1	-	200	-	pF
Reverse Transfer Capacitance	C _{res}	1	-	60	-	pF

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS			-			
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	21	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	56	-	ns
Turn-Off Delay Time	t _{d(off)}	7	_	126	-	ns
Fall Time	t _f	7	-	50	100	ns
Turn-On Switching Loss	E _{on}	7	-	1	1.5	mJ
Turn–Off Switching Loss	E _{off}		-	0.52	0.78	mJ
Total Switching Loss	E _{ts}		-	1.52	2.28	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \\ R_{G} = 10 \Omega, \text{ V}_{GE} = 15 \text{ V}, \\ \text{Inductive Load, } T_{C} = 125^{\circ}\text{C}$	-	20	-	ns
Rise Time	tr		_	54	-	ns
Turn-Off Delay Time	t _{d(off)}		_	131	-	ns
Fall Time	t _f	7	_	70	-	ns
Turn-On Switching Loss	E _{on}	7	-	1.1	-	mJ
Turn–Off Switching Loss	E _{off}	-	_	0.78	-	mJ
Total Switching Loss	E _{ts}		_	1.88	-	mJ
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	_	120	-	nC
Gate to Emitter Charge	Q _{ge}	1	-	14	-	nC
Gate to Collector Charge	Q _{gc}	1	_	58	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25° C unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 20 A	$T_{C} = 25^{\circ}C$	-	2.3	2.8	V
			T _C = 125°C	-	1.7	-	
Diode Reverse Recovery Time	t _{rr}	I_F = 20 A, di _F /dt = 200 A/µs	$T_C = 25^{\circ}C$	-	36	-	ns
			T _C = 125°C	-	105	-	
Diode Reverse Recovery Current	I _{rr}		$T_C = 25^{\circ}C$	-	2.6	-	А
			T _C = 125°C	-	7.8	-	
Diode Reverse Recovery Charge	Q _{rr}		$T_C = 25^{\circ}C$	-	46.8	-	nC
			T _C = 125°C	-	409	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

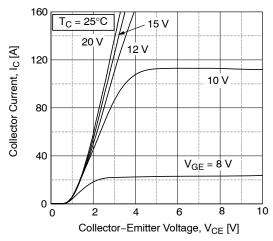


Figure 1. Typical Output Characteristics

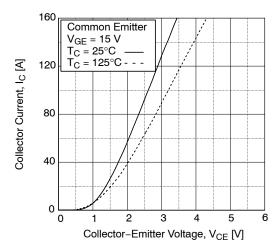
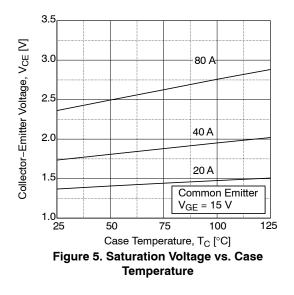
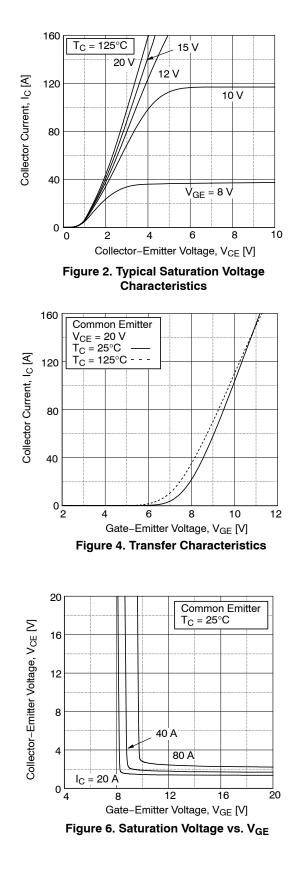


Figure 3. Typical Saturation Voltage Characteristics





TYPICAL PERFORMANCE CHARACTERISTICS (continued)

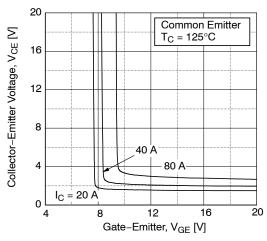


Figure 7. Saturation Voltage vs. V_{GE}

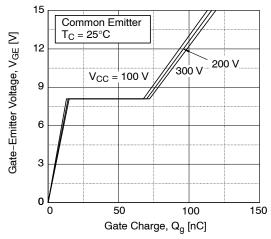
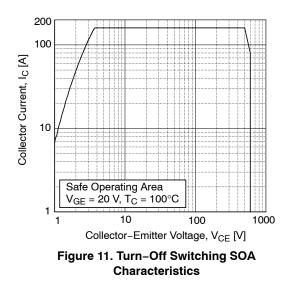
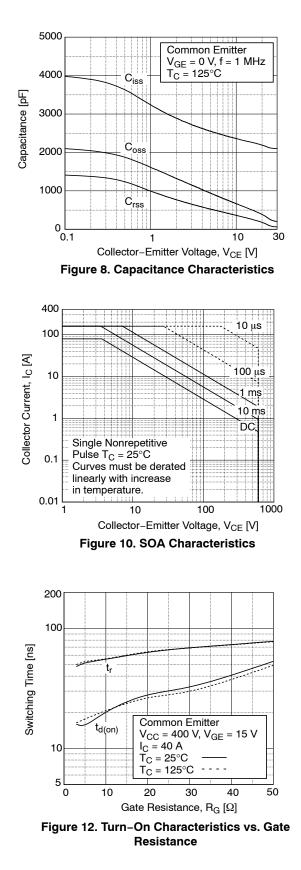
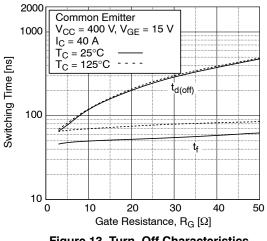


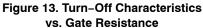
Figure 9. Gate Charge Characteristics





TYPICAL PERFORMANCE CHARACTERISTICS (continued)





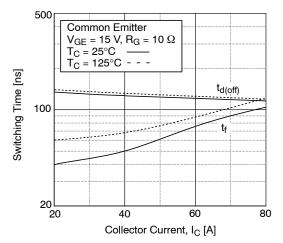


Figure 15. Turn-Off Characteristics vs. Collector Current

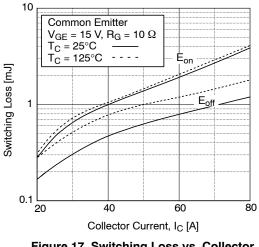
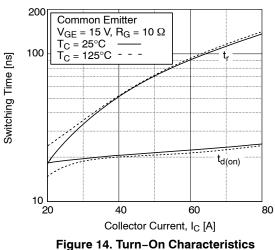
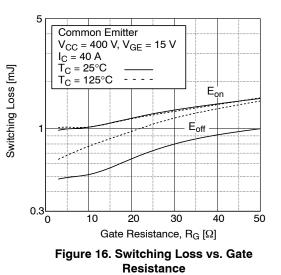


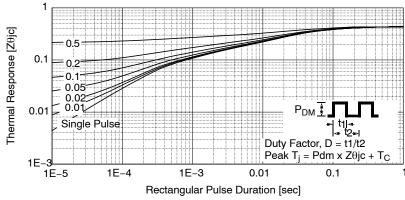
Figure 17. Switching Loss vs. Collector Current



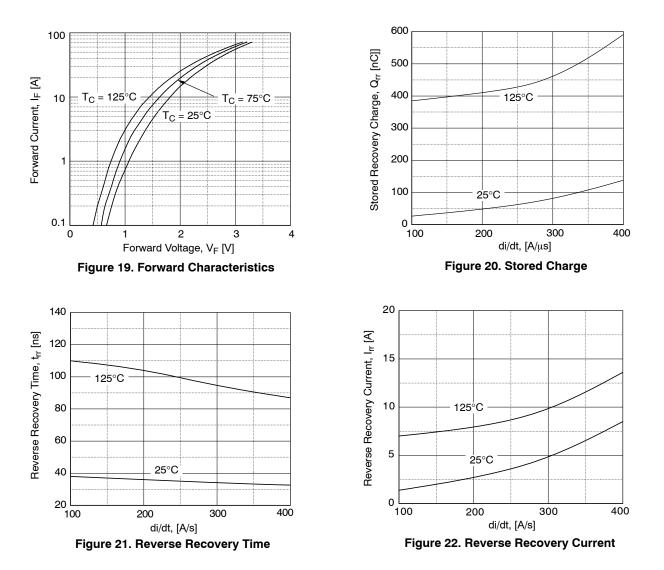
igure 14. Turn-On Characteristics vs. Collector Current



TYPICAL PERFORMANCE CHARACTERISTICS (continued)











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